Issue No.
 : EA-04-11-05-03S

 Date of Issue :
 05th. November, 2004

 Classification :
 ■New □Changed □Revised

PRODUCT SPECIFICATION

Product Description	:	Aluminium Electrolytic Capacitor
Product Part Number	:	A TYPE M SERIES
Country of Origin	:	Malaysia / Japan
Marking of the Origin	:	Printed on the packaging label
Classification of Spec.	:	Product specification
Applications	:	Set Top Box
		For other application, contact our person signed below.
Term of Validity	:	04 th . November, 2009 from the date of issue

CUSTOMER USE ONLY	Receipt Record # :
This was certainly received by us. One copy is being returned to the manufacturer within 2	Date of Receipt
months from the date of issue. If not, it shall be considered as accepted.	Received by :

- This capacitor is designed to be used for electronics circuits of, such as, audio/visual equipment, home appliances, computers and other office equipment, optical equipment, measuring equipment and industrial robots.
- No Ozone Depleting Chemicals (ODC's), controlled under the Montreal Protocol Agreement, are used in producing this product.
- This product does not contain PBBOs or PBBs.
- All the materials that are used for this product are registered as "Known Chemicals" in the Japanese act "Law Concerning the Examination and Regulation of Manufacture, etc. of Chemical Substances".
- This product is not subject to the control under Foreign Exchange and Foreign Trade Control Law of Japan as one of the strategic products.

Matsushita Electronic Devices (M) Sdn. Bhd. No.1 Jalan Jemuju 16/13, 40000 Shah Alam, Selangor Darul Ehsan, MALAYSIA. (P.O. Box 7720, Pejabat Pos Besar Shah Alam, 40724 Shah Alam, Selangor Darul Ehsan.)

Prepared by: Cu	stomer Engineeri	ng, R&D Center
Approved	Checked	Prepared
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	Miniature Aluminium Electrolytic C	Capacitor		EM-O-TE-B-F17-0
	A Type M Series			Contents
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tablished Date .06.2004	Matsushita Electronic D Electrolytic Capa			

	Miniature Aluminium Electrolytic Capacitor	EM-O-TE-B-F17-0
	A Type M Series	Page 1
1.0 Scope		
	s specification applies to Aluminium Electrolyte Capacitors for electro ch conform to JIS C 5141.	onic equipment use
2.0 Part num	<u>iber</u>	
	$\frac{\text{EC}}{2-1} \frac{\text{A}}{2-2} \frac{\text{OO}}{2-3} \frac{\text{M}}{2-4} \frac{\text{OOO}}{2-5} \frac{\text{\Box}}{2-6}$	
2-1	Aluminium Electrolytic Capacitor	
2-2	Type : Radial lead type (JIS:04 type)	
2-3	Rated voltage code	
	Voltage code 0J 1A 1C 1E 1V 1H 1J 2A Dated veltage 6.2 10 16 25 25 50 62 100	
	Rated voltage 6.3 10 16 25 35 50 63 100	
	Voltage code 2C 2D 2E 2V 2G 2W Rated voltage 160 200 250 350 400 450	
2-4	M series	
2-5	Capacitance code : Capacitance value in μ F is indicated by 3 figure. The first two figures denote the first two figure value. The third figure denotes the number of subseq capacitance value. "R" denotes the decimal point. Ex : 0.1μ F \rightarrow 0R1, 10μ F \rightarrow 100, 1000μ F	es of the capacitance uent zeros of the
2-6	Suffix code for appearance	
	Blank Standard long lead	
	E Snap-in lead	
	ILead taping (2.5mm pitch)BLead taping (5.0mm / 7.5mm pitch)	
	Refer to page 16 for snap-in lead dimensions, page $17 \sim 20$ for lead and page $21 \sim 24$ for lead taping specifications.	d taping dimensions,
emark		
tablished Date	Matsushita Electronic Devices (M) Sdn. Bhd.	
).06.2004	Electrolytic Capacitor Division	

	1.111116			trolytic Ca	.puonor			E-B-F17
		A	Type M Se	51105				
an size			grunnongezen ov verse var stade häveden				ΦD x I	L [mm]
Ψ.V. (V. DC) p (μF)	6.3	10	16	25	35	50	63	100
0.1				l		5x11		
0.22						5x11		
0.33						5x11		
0.47						5x11		5x11
0.68						5x11		
1						5x11	5x11	5x11
2.2						5x11	5x11	5x11
3.3						5x11		5x11
4.7						5x11	5x11	5x11
6.8						5x11		
10			5x11	5x11	5x11	5x11	5x11	5x11
22			5x11	5x11	5x11	5x11	5x11	6.3x11.2
33	5x11		5x11	5x11	5x11	5x11	6.3x11.2	8x11.5
47	5x11		5x11	5x11	5x11	6.3x11.2	6.3x11.2	8x11.5
68			5x11					
100	5x11	5x11	5x11	6.3x11.2	6.3x11.2	8x11.5	8x11.5 10x12.5 S	10x16
220	5x11	6.3x11.2 5x11 U	6.3x11.2	8x11.5	8x11.5	10x12.5	10x16	12.5x20
330	6.3x11.2	6.3x11.2	8x11.5	8x11.5	10x12.5	10x16	10x20	12.5x25
470	6.3x11.2	8x11.5 6.3x11.2 U	8x11.5	10x12.5	10x16	10x20	12.5x20	16x25
1000	8x11.5	10x12.5	10x16 8x20 L 10x12 U	10x20 10x16 U	12.5x20 10x20 U	12.5x25	16x25	18x35.5
2200	10x16	10x20 10x16 U	12.5x20	12.5x25	16x25	16x31.5	18x35.5	
3300	10x20	12.5x20	12.5x25	16x25	16x31.5	18x35.5		
3900	* 0/XWV	12.01120	16x20 U	16x25				
4700	12.5x20	12.5x25	16x25	16x31.5 18x25 S	18x35.5	MANAGAMAN (1991)		
5600				10/20 0	18x35.5			*****
6800	12.5x25	16x25	16x31.5	18x35.5	10/00010			
8200	1 m , 0 / 1 m 0			18x35.5				
10000	16x25	16x31.5	18x35.5					
15000	16x31.5	18x35.5	10.0000					
22000	18x35.5							
mark								

Established Date 10.06.2004

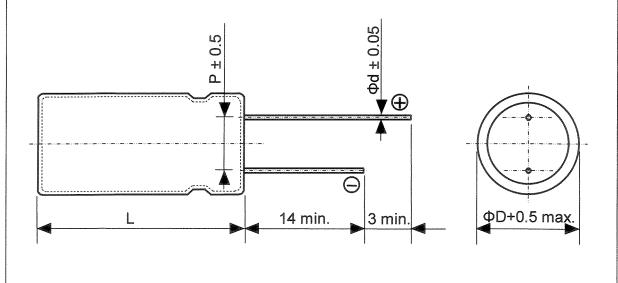
	Miniatu	re Alumini	um Electro	olytic Capa	acitor		EM-O-TE-B-F17-0
		А Ту	pe M Serie	es			Page 3
	160V ~ 45	0V			ΦD x I	_ [mm]	
W.V. (V. DC)		200	250	350	400		
Cap (µF)	100	200	230	330	400	450	
0.47	5x11		5x11				
1	6.3x11.2	6.3x11.2	6.3x11.2	6.3x11.2	6.3x11.2	8x11.5	
2.2	6.3x11.2	6.3x11.2	6.3x11.2	8x11.5	8x11.5	10x12.5	
3.3	6.3x11.2	6.3x11.2	8x11.5	8x11.5	10x12.5	10x16	
4.7	6.3x11.2	8x11.5	8x11.5	10x12.5	10x16	10x20	
6.8	8x11.5				10x16		
10	10x12.5	10x12.5	10x16	10x20	10x20	12.5x20	
22	10x16	10x20 10x16 U	10x20	12.5x20	12.5x25	16x25	
33	10x20	10x20	12.5x20	16x25	16x25	16x31.5	1
47	12.5x20	12.5x20	12.5x25	16x25	16x31.5		-
68					16x31.5 U		1
82		16x25			18x35.5		1
100	12.5x25	16x25 18x20 S	16x31.5		18x40		
150		16x31.5					
220	16x31.5	16x31.5 U	18x40				-
330		18x40 18 x 35.5 U					
470	18x40					manaaaaaaaaaaaaaaaaaaaaaaaaaaaaaaaaaaa	1
emark							

Miniature Aluminium Electrolytic Capacitor	EM-O-TE-B-F17-01
A Type M Series	Page 4
3.0 Standard ratings	

No	Item		Ratings							
1	Operating temperature range	2		-40 ~ ·	+85 °C			-25 ~ ·	+85 °C	
2	Rated working voltage range			6.3 ~ 10	0 V D.C.		160~450 V D.C.			
3	Nominal capacitance range		0.1 ~ 22000 μF (120Hz 20°C)				0.47 ~ 470 μF (120Hz 20°C			
4	Capacitance tolerance									
		W.V	6.3	10	16	25	35	50	63	100
5	Suma valtara (V.D.C.)	S.V	8	13	20	32	44	63	79	125
3	Surge voltage (V D.C.)	W.V	160	200	250	350	400	450		
		S.V	200	250	300	400	450	500		
6	Permissible ripple current	,00000000000000000000000000000000000000				Page 1	1~15			

4.0 Dimension and appearance

- Vinyl sleeve colour (dark blue), product marking (white)Standard long lead (Suffix : blank) :-

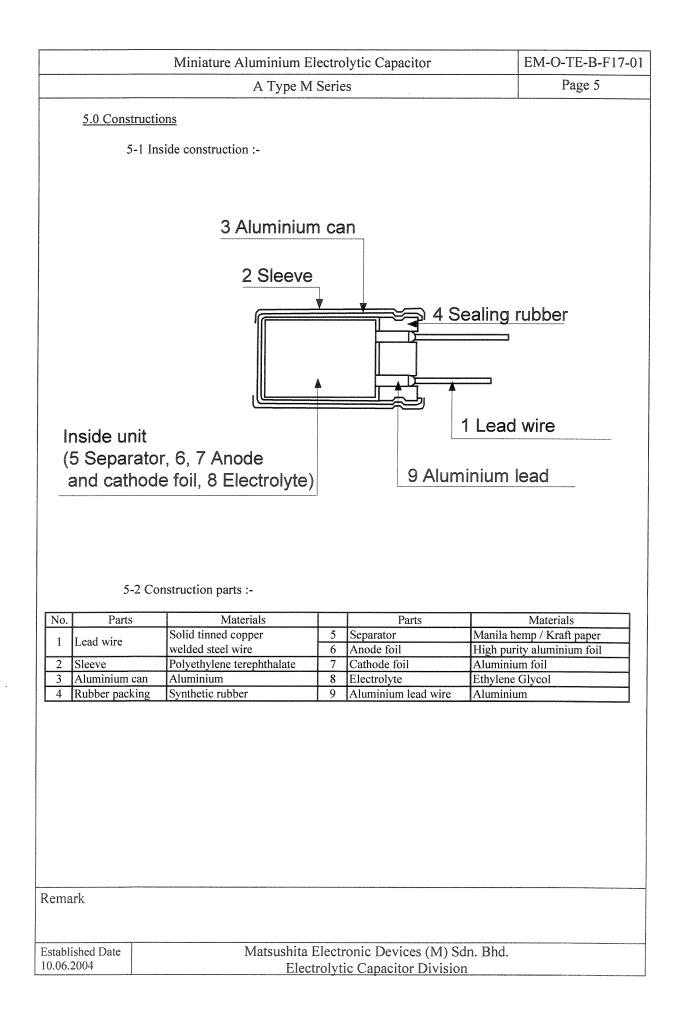


$L \leq ~16:L+1.0$ max.

$L \ge 20 : L + 2.0 \text{ max.}$						[unit	: mm]
Body diameter, ΦD	5	6.3	8	10	12.5	16	18
Lead pitch, P	2.0	2.5	3.5	5.0	5.0	7.5	7.5
Lead diameter, Φd	0.5	0.5	0.6	0.6	0.6	0.8	0.8

Remark

Established Date	Matsushita Electronic Devices (M) Sdn. Bhd.
10.06.2004	Electrolytic Capacitor Division



		N	/iniature Aluminium Electrolytic Cap	acitor		EM-O-TE-B-	F17-(
			A Type M Series			Page 6		
	6.0 Perform	ance C	<u>Characteristics</u>					
No	Item		Performance Characteristics		T	est		
1 Leakage current			 6.3V~100V : I ≤ 0.01CV or 3µA whichever is greater. 160V~450V : I ≤ 0.06CV+10µA I : Leakage current C : Capacitance V : Rated voltage 	Appl	Series resistor : $1000 \pm 10 \Omega$ Applied voltage : Rated working voltage Measuring : After 2 minutes			
2 Capacitance			Within the specified capacitance tolerance	V : Rated voltage Measure Within the specified capacitance tolerance Measure Measure Measure			cuit	
3	3 tan δ		Less than the values in Table 1 of Page 10 Add 0.02 per 1000µF for products which capacitance value is above 1000µF.	Meas	uring voltage : +1	uvalent series circ		
4	Temperature	Step	Impedance ratio :	Step	Test temperati	ure Time	9	
	characteristics	2	Less than values in Table 2 of Page 10.	1	20 ± 2°C	-		
			Leakage current :	2	8	_*		
		4	\leq 500% of value of Item 6.1	3	20 ± 2°C	15 mint	ites	
			Capacitance change :	4	85 ± 2°C	2 hou	rs	
			Within ±25% of value in Step 1 tan δ	5	20 ± 2°C	asured at frequence		
			≤ the value of Item 6.3	 of 120 Hz ± 10% ■ 6.3V ~ 100V : -25 ± 3 °C, -40 ± 3 °C 160V ~ 450V : -25 ± 3 °C * The capacitor should be stored at the impedance or capacitance are stabilized. 				
5 Surge voltage		te voltage Leakage current : ≤ the value of Item 6.1 Capacitance change : Within ±15% of initial tan δ		Series R : pro	Test temperature : $15 \sim 35^{\circ}C$ Series resistor : $R = 100 \pm 50$ C R : protective resistor ($k\Omega$) C : nominal capacitance (μ F)			
			\leq the value of Item 6.3	R	oltage : Item 3.5			
			Appearance : No significant change can be observed.	No. of	No. of cycles : 1000 cycles Each cycle lasts for 6 ± 0.5 min, "ON" for 30 ± 5 s			
					"OFF" fo	or 5 ± 0.5 min.		

		Miniature Aluminium Electrolytic Capac		EM-O-TE-B-F17 Page 7				
		A Type M Series		rage /				
No	Item	Performance Characteristics	1	Test				
6	Lead terminal	There is no damage or breakage after	Lead pull strength					
		test	Diameter [mm]	Pull strength [N]				
			Φ0.50	5				
			$\Phi 0.60 \sim \Phi 0.80$	10				
			Pull strength is app	lied axially for				
			10 ± 1 seconds.					
			Lead bending stren	gth				
			Diameter [mm]	Static load [N]				
			Φ 0.50	2.5				
			$\Phi 0.60 \sim \Phi 0.80$	5.0				
			The capacitor is pla	L				
			position. The weigh					
			above table is appl					
			The capacitor is slo					
			to horizontal position					
			return to vertical po					
			bendings shall last					
			Additional bends s	hall be made in the				
			opposite direction.					
7	Resistance to	Capacitance :	Frequency : 10~55					
	vibration	During the test, measured value shall be						
		stabilized.	Vibration distance : 1.5 mm Direction and duration of vibration :					
		(Measure several times within 30 mins						
		before completion of test. The value		K,Y,Z axis direction				
		shall be monitored from and to both	for 2 hours each,	with a total of 6				
		ends of the frequency values.	hours.					
		Appearance :	Mounting methods					
		No significant change can be observed.		all be fixed with its				
		Capacitance change :	lead wires at the point of 4mm from					
		Within $\pm 5\%$ of initial value.	the bottom of capacitor body. Capacitor greater than 12.5mm					
			diameter or longe	r than 25mm must				
			be fixed in place	with a bracket.				
8	Solderability	More than 3/4 of the terminal surface	Solder : H60A, H60	S, or H63A				
		shall be covered with new solder.	Solder temperature	: 235 ± 5°C				
			Immersing time : 2 ±					
			Immersing depth : 1					
			Flux : Approx 25%					
			in ETHANOL					
9	Resistance to	Leakage current :	Solder : H60A, H60					
	soldering heat	≤ the value of Item 6.1	Solder temperature					
	-	Capacitance change :	Immersing time : 10					
		Within $\pm 10\%$ of initial measured value	Immersing depth : 1	1				
		tan δ:						
		\leq the value of Item 6.3						
		Appearance :						
		No significant change can be observed.						
1		1 1.0 organization on ange can be observed.	1					
ma	rk							
	shed Date	Matsushita Electronic Device	es (M) Sdn Bhd					
ahli	SHELLIARE I							

Item Permanency of marking	A Type M Series Performance Characteristics There shall be no damage and legible marked. Marking shall be deciphered	Class of reagent : I	Page 8
Permanency of	There shall be no damage and legible		Taat
Permanency of	There shall be no damage and legible		Loot
		iciass of reagent : 1	
marking			SOPROPYL ALCOHOL
	easily.		(JIS K8034) or
			superior
		Test temperature : 2	
		Immersing time : 3	0 ± 5 s
Vent	Vent shall operate without any	• AC current metho	od :
			D
$anameter \ge \Psi 0.3$)			Ŵ
	approaction of voltage.		
		AC power	C× 1111
			Ĭ
		50Hz or 60Hz	D · Sorios resist.
		IV	R : Series resistor
			Cx : Tested capacito
			s to rated W V v
		smaller.	
		Nominal cap.	DC resistance
			<u>(Ω)</u>
			1000 ± 100 100 ± 10
			100 ± 10 10 ± 1
		> 100 ≤ 1000	1 ± 0.1
		> 1000 ≤ 10000	0.1 ± 0.01
		> 10000	*
			01 103104
		Reverse voltage m	ethod :
			<u> </u>
		+	
			C× 7
			<u></u> +
		- L	<u> </u>
		A : DC ammeter	Cx : Tested capacite
		Diameter (mm)	DC (A)
		processor contraction contraction to all contractions and the second contraction of the second c	1 (constant)
		> 22.4	10 (constant)
	Vent (for products with diameter $\ge \Phi$ 6.3)	(for products with hazardous expulsion or emission of flame.	Vent (for products with diameter $\ge \Phi$ 6.3) Vent shall operate without any hazardous expulsion or emission of flame. No emission of gas after 30 minutes application of voltage. AC cover $\underbrace{\bigcirc}$ $AC cover \underbrace{\bigcirc}$ $AC cover \underbrace{\bigcirc}$ $AC menter \bigcircAC cover \underbrace{\bigcirc}AC cover \underbrace{\frown}AC cove$

Miniature Aluminium Electrolytic Capacitor	EM-O-TE-B-F17-01
A Type M Series	Page 9

No	Item	Performance Characteristics	Test
	Moisture	Leakage current :	Test temperature : $40 \pm 2^{\circ}C$
	Resistance	\leq the value of Item 6.1	Relative humidity : 90 ~ 95%
	(Steady State)	Capacitance change :	Test duration : 240 ± 8 hours
		Within \pm 20% of initial measured value	
		tan δ	After subjected to the test, the
		\leq 120% the value of Item 6.3	capacitor shall be left for 2 hours at
		Appearance :	room temperature and room
Constant of the second		No significant change can be observed.	humidity before measurement is
			performed.
13	Endurance	Leakage current :	Test temperature : $85 \pm 2^{\circ}C$
		\leq the value of Item 6.1	Test duration : 2000 $\frac{+72}{-0}$ hours
		Capacitance change :	Applied voltage : D.C. voltage with
		Within $\pm 20\%$ of initial measured value	specified ripple
		tan δ	current.
10000		\leq 150% the value of Item 6.3	The sum of DC and ripple peak
		Appearance :	current shall not exceed the rated
		No significant change can be observed.	working voltage. After subjected to
			the test, the capacitor shall be left
			at room temperature and room
			humidity for 2 hours before
			measurement is performed.
14	Shelf life	Leakage current :	Test temperature : $85 \pm 2^{\circ}C$
		\leq the value of Item 6.1	Test duration : $1000 \frac{+48}{-0}$ hours
		Capacitance change :	
		Within $\pm 20\%$ of initial measured value	After subjected to the test, DC
		tan δ	working voltage shall be applied to
		\leq 150% the value of Item 6.3	the capacitor for 30 minutes as post-
		Appearance :	test treatment. The capacitor shall be
		No significant change can be observed.	left at room temperature and room
			humidity for 2 hours before
			measurement is performed.

Remark

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	EM-O-TE-B-F17
A Type M Series	Page 10
7.0 Marking	
Marking indicated on the products :	
a) Rated working voltage	
b) Nominal capacitance	
c) Negative polarity	
d) Manufacturer's identification	
e) Maximum operating temperature	
f) Series Codeg) Lot no. (or date code)	
8.0 Others	
Unless specified otherwise, the product shall conform to JIS C 5141.	
m Table 1 $\tan \delta$	100
W.V. (V D.C.)6.3101625355063 $\tan \delta$ 0.280.240.200.160.140.120.11	0.10
	underson in the second
W.V. (V D.C.) 160 200 250 350 400 450	
$\tan \delta$ 0.160.180.180.200.200.20Add 0.02 per 1000µF for product with capacitance value greater than 1000µF	
Add 0.02 per 1000pt for product with capacitatice value greater than 1000pt	
Table 2Temperature characteristics (Impedance ratio at 120Hz)W.V. (V D.C.)6.31016253550	53 100
	2 2
Z(-40°C)/Z(20°C) 12 10 8 5 4 3	3 3
1. Add 0.5 per 1000µF for products more than 1000µF at -25°C	
2. Add 1.0 per 1000 μ F for products more than 1000 μ F at -40°C	
W.V. (V D.C.)160200250350400450 $Z(-25^{\circ}C)/Z(20^{\circ}C)$ 223566	
Table 3Frequency correction factor for ripple currentFrequency (Hz)50, 601201k10k~	
Frequency (Hz)50, 601201k10k \sim Coefficient0.711.31.7	
ark	
ark Nished Date Matsushita Electronic Devices (M) Sdn. Bho 5.2004 Electrolytic Capacitor Division	I.

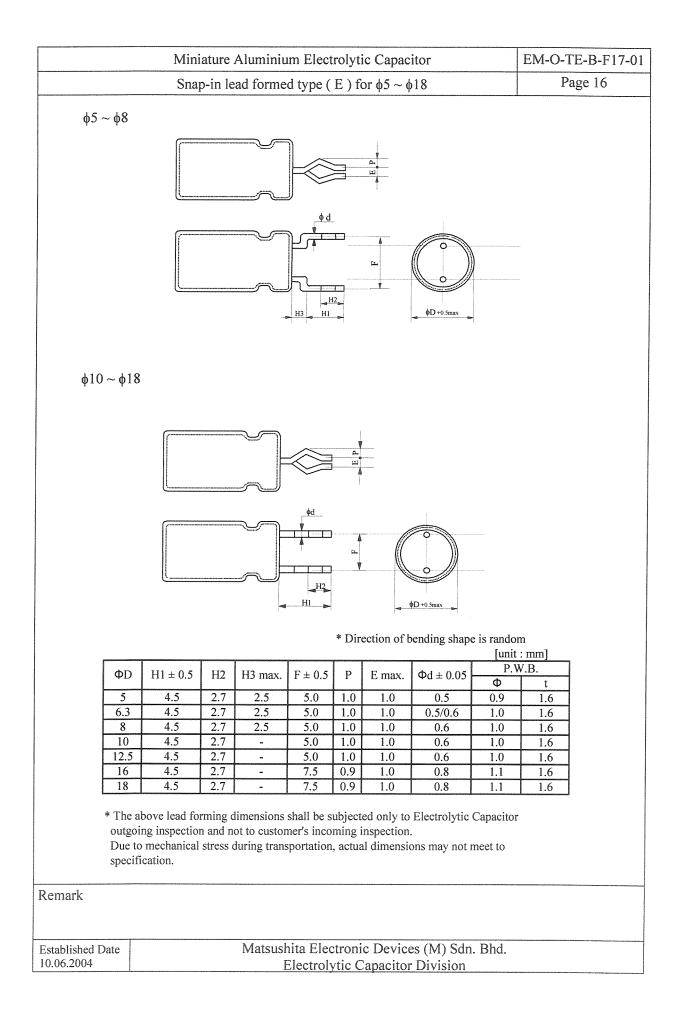
	Miniatu					bacitor			A-O-TE	
Oton dond	long load trues	A	Туре М	4 Series					Page	: 11
Standard	long lead type				1	Ripple			911ChmCimtion1119199999999999	
Customer Part No	Matsushita Part No	W.V. (V D.C.)	Cap (µF)	tan δ	D.C.L. (µA)	current (mA rms.)		Dim	. (mm)	
		ļ		<u> </u>	L	*1	φD	L	F	ød.
	ECA0JM330	6.3	33	0.28	3.0	60	5	11	2.0	0.50
	ECA0JM470	6.3	47	0.28	3.0	60	5	11	2.0	0.50
	ECA0JM101 ECA0JM221	6.3 6.3	100 220	0.28	6.3 13.8	130 240	5 5	<u>11</u> 11	2.0	0.50
	ECA0JM221 ECA0JM331	6.3	330	0.28	20.7	300	6.3	11.2	2.5	0.50
	ECA0JM471	6.3	470	0.28	29.6	380	6.3	11.2	2.5	0.50
	ECA0JM102	6.3	1000	0.28	63.0	580	8	11.5	3.5	0.60
	ECA0JM222	6.3	2200	0.30	138.6	890	10	16	5.0	0.60
0.4096.20	ECA0JM332	6.3	3300	0.32	207.9	1020	10	20	5.0	0.60
	ECA0JM472	6.3	4700	0.34	296.1	1170	12.5	20	5.0	0.60
	ECA0JM682	6.3	6800	0.38	428.4	1270	12.5	25	5.0	0.60
	ECA0JM103	6.3	10000	0.46	630.0	1450	16	25	7.5	0.80
	ECA0JM153	6.3	15000	0.56	945.0	1700	16	31.5	7.5	0.80
	ECA0JM223	6.3	22000	0.70	1386.0	1900	18	35.5	7.5	0.80
	ECA1AM101	10	100	0.24	10.0	150	5	11	2.0	0.50
	ECAIAMI01 ECAIAM221	10	220	0.24	22.0	250	6.3	11.2	2.0	0.50
	ECAIAM221U	10	220	0.24	22.0	240	5	11.2	2.0	0.50
	ECA1AM331	10	330	0.24	33.0	330	6.3	11.2	2.5	0.50
	ECA1AM471	10	470	0.24	47.0	400	8	11.5	3.5	0.60
	ECA1AM471U	10	470	0.24	47.0	350	6.3	11.2	2.5	0.50
	ECA1AM102	10	1000	0.24	100.0	630	10	12.5	5.0	0.60
	ECA1AM222	10	2200	0.26	220.0	920	10	20	5.0	0.60
	ECA1AM222U	10	2200	0.26	220.0	920	10	16	5.0	0.60
	ECA1AM332	10	3300	0.28	330.0	1090	12.5	20	5.0	0.60
	ECA1AM472	10	4700	0.30	470.0	1200	12.5	25	5.0	0.60
	ECA1AM682	10 10	6800 10000	0.34	680.0 1000.0	1400 1600	16 16	25 31.5	7.5	0.80
	ECA1AM103 ECA1AM153	10	15000	0.42	1500.0	1850	10	35.5	7.5	0.80
	Lenniniss	10	15000	0.02	1200.0	1050	10		/.5	0.00
	ECA1CM100	16	10	0.20	3.0	30	5	11	2.0	0.50
	ECA1CM220	16	22	0.20	3.5	75	5	11	2.0	0.50
	ECA1CM330	16	33	0.20	5.2	110	5	11	2.0	0.50
	ECA1CM470	16	47	0.20	7.5	130	5	11	2.0	0.50
	ECA1CM680	16	68	0.20	10.9	140	5	11	2.0	0.50
	ECA1CM101	16	100	0.20	16.0	180	5	11	2.0	0.50
and the second	ECA1CM221	16	220	0.20	35.2	280	6.3 °	11.2	2.5	0.50
	ECA1CM331	16	330	0.20	52.8 75.2	350 440	8 8	<u>11.5</u> 11.5	3.5 3.5	0.60
	ECA1CM471 ECA1CM102	16 16	470 1000	0.20	160.0	680	8 10	11.5	5.0	0.60
	ECAICM102 ECAICM102L	16	1000	0.20	160.0	680	8	20	3.5	0.60
	ECAICM102L	16	1000	0.20	160.0	680	10	12.5	5.0	0.60
	ECA1CM222	16	2200	0.20	352.0	1000	12.5	20	5.0	0.60
	ECA1CM332	16	3300	0.24	528.0	1200	12.5	25	5.0	0.60
nark *1	120Hz 8:	5°C								
blished Date	120112 0.		tsushita	Electro	onic De	vices (M)	Sdn. Bl	nd.		

Matsushita Part No CA1CM472 CA1CM472U	W.V. (V D.C.)	Cap (µF)	tan δ		Ripple				
			max.	L.C. (µA)	current (mA rms.)		Dim.	(mm)	
				max.	max. *1	φD	L	P	φd
CA1CM472U	16	4700	0.26	752.0	1360	16	25	7.5	0.8
	16	4700	0.26	752.0	1088	16	20	7.5	0.80
CA1CM682	16	6800	0.34	1088.0	1600	16	31.5	7.5	0.80
CATCM103	16	10000	0.42	1600.0	1800	18		1.5	0.80
CAIEMIOO	25	10	0.16	3.0	50	5	11	20	0.50
						*****		CONTRACTOR OF CO	0.50
Address to a feat of the second strength of t	have been a second s	The second second second second second		Construction of the local distance of the lo	Summer and s			A COLORED STATEMENT OF THE OWNER	0.50
									0.50
CA1EM101	25	100	0.16	25.0	180	6.3	11.2	2.5	0.50
CA1EM221	25	220	0.16	55.0	310	8	11.5	3.5	0.60
CA1EM331	25	330	0.16	82.5	390	8	11.5	3.5	0.60
CA1EM471	2		0.16	117.5	480	10	12.5		0.60
CA1EM102			0.16	and the second se			*******		0.60
									0.60
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	the second se	and a state of the	And the owner of the owner			****	the state of the s		0.80
									0.80
CALIFORNIA CONTRACTOR ACTOR AC	h		and a state of the	and a second sec		Construction in the American State of the State	And the second of the second se		0.80
				(compared to the second se				and the second se	0.80
CA1EM822	25	8200	0.30	2050.0	1750	18	35.5	7.5	0.80
									0.50
	and the second se								0.50
				the second se					0.50
				Construction and the second	the second se	and the second se			0.50
				·····					0.60
									0.60
CA1VM471	35	470	0.14	164.5	550	10	16	5.0	0.60
CA1VM102	35	1000	0.14	350.0	900	12.5	20	5.0	0.60
CA1VM102U	35	1000	0.14	350.0	900	10	20	5.0	0.60
CA1VM222	35	2200	0.16	770.0	1250	16	25	7.5	0.80
CA1VM332		3300	CONTRACTOR OF THE OWNER OWNE						0.80
									0.80
JAT V MI362	35	000	0.22	1043.0	1000	18	35.5	1.5	0.80
	CA1EM221 CA1EM331 CA1EM471 CA1EM102 CA1EM102U CA1EM102U CA1EM222 CA1EM332 CA1EM332 CA1EM472 CA1EM472 CA1EM472 CA1EM682 CA1EM822 CA1VM100 CA1VM200 CA1VM201 CA1VM211 CA1VM471 CA1VM102 CA1VM102 CA1VM102U CA1VM222	CA1EM100 25 CA1EM20 25 CA1EM300 25 CA1EM300 25 CA1EM300 25 CA1EM300 25 CA1EM470 25 CA1EM21 25 CA1EM21 25 CA1EM31 25 CA1EM102 25 CA1EM102 25 CA1EM102 25 CA1EM102 25 CA1EM32 25 CA1EM32 25 CA1EM32 25 CA1EM472 25 CA1EM472 25 CA1EM472 25 CA1EM62 25 CA1EM62 25 CA1VM20 35 CA1VM300 35 CA1VM300 35 CA1VM101 35 CA1VM21 35 CA1VM31 35 CA1VM102 35 CA1VM102 35 CA1VM32 35 CA1VM32	CA1EM100 25 10 CA1EM220 25 22 CA1EM330 25 33 CA1EM330 25 33 CA1EM470 25 47 CA1EM101 25 100 CA1EM221 25 220 CA1EM221 25 220 CA1EM331 25 330 CA1EM102 25 1000 CA1EM102 25 1000 CA1EM102 25 1000 CA1EM102 25 1000 CA1EM32 25 3300 CA1EM32 25 3900 CA1EM472 25 4700 CA1EM472 25 4700 CA1EM472 25 8200 CA1EM822 25 8200 CA1EM822 25 8200 CA1VM20 35 10 CA1VM210 35 10 CA1VM220 35 22 CA1VM331 35 <td< td=""><td>CA1EM100 25 10 0.16 CA1EM220 25 22 0.16 CA1EM330 25 33 0.16 CA1EM330 25 33 0.16 CA1EM470 25 47 0.16 CA1EM470 25 47 0.16 CA1EM101 25 100 0.16 CA1EM221 25 220 0.16 CA1EM331 25 330 0.16 CA1EM471 25 470 0.16 CA1EM102 25 1000 0.16 CA1EM102 25 1000 0.16 CA1EM102 25 1000 0.16 CA1EM32 25 3300 0.20 CA1EM32 25 3900 0.20 CA1EM472 25 4700 0.22 CA1EM472 25 4700 0.22 CA1EM472 25 8200 0.30 CA1EM472 25 8200 0.30</td><td>CA1EM100 25 10 0.16 3.0 CA1EM220 25 22 0.16 5.5 CA1EM330 25 33 0.16 8.2 CA1EM330 25 47 0.16 11.7 CA1EM470 25 47 0.16 11.7 CA1EM101 25 100 0.16 25.0 CA1EM221 25 220 0.16 55.0 CA1EM331 25 330 0.16 82.5 CA1EM102 25 1000 0.16 250.0 CA1EM102 25 1000 0.16 250.0 CA1EM102U 25 1000 0.16 250.0 CA1EM102U 25 1000 0.16 250.0 CA1EM32 25 3000 0.20 825.0 CA1EM32 25 4700 0.22 1175.0 CA1EM472 25 4700 0.22 1175.0 CA1EM472 25 8200 <</td><td>CA1EM100 25 10 0.16 3.0 50 CA1EM20 25 22 0.16 5.5 90 CA1EM330 25 33 0.16 8.2 110 CA1EM330 25 47 0.16 11.7 130 CA1EM470 25 47 0.16 11.7 130 CA1EM101 25 100 0.16 25.0 180 CA1EM221 25 220 0.16 55.0 310 CA1EM331 25 330 0.16 82.5 390 CA1EM471 25 470 0.16 117.5 480 CA1EM102 25 1000 0.16 250.0 850 CA1EM102 25 1000 0.16 250.0 850 CA1EM122 25 200 0.18 550.0 1200 CA1EM322 25 3900 0.20 975.0 1500 CA1EM32 25 4700</td><td>CA1EM100 25 10 0.16 3.0 50 5 CA1EM20 25 22 0.16 5.5 90 5 CA1EM330 25 33 0.16 8.2 110 5 CA1EM470 25 47 0.16 11.7 130 5 CA1EM470 25 47 0.16 55.0 310 8 CA1EM221 25 220 0.16 55.0 310 8 CA1EM331 25 330 0.16 82.5 390 8 CA1EM102 25 1000 0.16 250.0 850 10 CA1EM102 25 1000 0.16 250.0 850 10 CA1EM102 25 1000 0.16 250.0 850 10 CA1EM122 25 300 0.20 975.0 1500 16 CA1EM32 25 4700 0.22 1175.0 1500 18</td><td>CA1EM100 25 10 0.16 3.0 50 5 11 CA1EM20 25 22 0.16 5.5 90 5 11 CA1EM30 25 33 0.16 8.2 110 5 11 CA1EM30 25 47 0.16 11.7 130 5 11 CA1EM101 25 47 0.16 11.7 130 5 11 CA1EM21 25 220 0.16 55.0 310 8 11.5 CA1EM31 25 330 0.16 82.5 390 8 11.5 CA1EM102 25 1000 0.16 25.0 850 10 12.5 CA1EM102 25 1000 0.16 25.0 850 10 16 CA1EM122 25 200 0.18 55.0 1200 12.5 25 CA1EM122 25 3900 0.20 975.0 1500</td><td>CA1EM100 25 10 0.16 3.0 50 5 11 2.0 CA1EM220 25 22 0.16 5.5 90 5 11 2.0 CA1EM30 25 33 0.16 8.2 110 5 11 2.0 CA1EM470 25 47 0.16 11.7 130 5 11 2.0 CA1EM101 25 100 0.16 25.0 180 6.3 11.2 2.5 CA1EM101 25 200 0.16 55.0 310 8 11.5 3.5 CA1EM102 25 1000 0.16 25.0 850 10 12.5 5.0 CA1EM102 25 1000 0.16 250.0 850 10 16 5.0 CA1EM222 25 2000 0.20 975.0 1500 16 25 7.5 CA1EM222 25 4700 0.22 1175.0 150</td></td<>	CA1EM100 25 10 0.16 CA1EM220 25 22 0.16 CA1EM330 25 33 0.16 CA1EM330 25 33 0.16 CA1EM470 25 47 0.16 CA1EM470 25 47 0.16 CA1EM101 25 100 0.16 CA1EM221 25 220 0.16 CA1EM331 25 330 0.16 CA1EM471 25 470 0.16 CA1EM102 25 1000 0.16 CA1EM102 25 1000 0.16 CA1EM102 25 1000 0.16 CA1EM32 25 3300 0.20 CA1EM32 25 3900 0.20 CA1EM472 25 4700 0.22 CA1EM472 25 4700 0.22 CA1EM472 25 8200 0.30 CA1EM472 25 8200 0.30	CA1EM100 25 10 0.16 3.0 CA1EM220 25 22 0.16 5.5 CA1EM330 25 33 0.16 8.2 CA1EM330 25 47 0.16 11.7 CA1EM470 25 47 0.16 11.7 CA1EM101 25 100 0.16 25.0 CA1EM221 25 220 0.16 55.0 CA1EM331 25 330 0.16 82.5 CA1EM102 25 1000 0.16 250.0 CA1EM102 25 1000 0.16 250.0 CA1EM102U 25 1000 0.16 250.0 CA1EM102U 25 1000 0.16 250.0 CA1EM32 25 3000 0.20 825.0 CA1EM32 25 4700 0.22 1175.0 CA1EM472 25 4700 0.22 1175.0 CA1EM472 25 8200 <	CA1EM100 25 10 0.16 3.0 50 CA1EM20 25 22 0.16 5.5 90 CA1EM330 25 33 0.16 8.2 110 CA1EM330 25 47 0.16 11.7 130 CA1EM470 25 47 0.16 11.7 130 CA1EM101 25 100 0.16 25.0 180 CA1EM221 25 220 0.16 55.0 310 CA1EM331 25 330 0.16 82.5 390 CA1EM471 25 470 0.16 117.5 480 CA1EM102 25 1000 0.16 250.0 850 CA1EM102 25 1000 0.16 250.0 850 CA1EM122 25 200 0.18 550.0 1200 CA1EM322 25 3900 0.20 975.0 1500 CA1EM32 25 4700	CA1EM100 25 10 0.16 3.0 50 5 CA1EM20 25 22 0.16 5.5 90 5 CA1EM330 25 33 0.16 8.2 110 5 CA1EM470 25 47 0.16 11.7 130 5 CA1EM470 25 47 0.16 55.0 310 8 CA1EM221 25 220 0.16 55.0 310 8 CA1EM331 25 330 0.16 82.5 390 8 CA1EM102 25 1000 0.16 250.0 850 10 CA1EM102 25 1000 0.16 250.0 850 10 CA1EM102 25 1000 0.16 250.0 850 10 CA1EM122 25 300 0.20 975.0 1500 16 CA1EM32 25 4700 0.22 1175.0 1500 18	CA1EM100 25 10 0.16 3.0 50 5 11 CA1EM20 25 22 0.16 5.5 90 5 11 CA1EM30 25 33 0.16 8.2 110 5 11 CA1EM30 25 47 0.16 11.7 130 5 11 CA1EM101 25 47 0.16 11.7 130 5 11 CA1EM21 25 220 0.16 55.0 310 8 11.5 CA1EM31 25 330 0.16 82.5 390 8 11.5 CA1EM102 25 1000 0.16 25.0 850 10 12.5 CA1EM102 25 1000 0.16 25.0 850 10 16 CA1EM122 25 200 0.18 55.0 1200 12.5 25 CA1EM122 25 3900 0.20 975.0 1500	CA1EM100 25 10 0.16 3.0 50 5 11 2.0 CA1EM220 25 22 0.16 5.5 90 5 11 2.0 CA1EM30 25 33 0.16 8.2 110 5 11 2.0 CA1EM470 25 47 0.16 11.7 130 5 11 2.0 CA1EM101 25 100 0.16 25.0 180 6.3 11.2 2.5 CA1EM101 25 200 0.16 55.0 310 8 11.5 3.5 CA1EM102 25 1000 0.16 25.0 850 10 12.5 5.0 CA1EM102 25 1000 0.16 250.0 850 10 16 5.0 CA1EM222 25 2000 0.20 975.0 1500 16 25 7.5 CA1EM222 25 4700 0.22 1175.0 150

Standard I				Electrol		pacitor			EM-O-T	www.aaa.aaa
Standard l		A	Туре №	1 Series					Pa	ge 13
	long lead type									
				<u> </u>		Ripple		5.		
Customer Part No	Matsushita Part No	W.V. (V D.C.)	Cap (µF)	tan δ	L.C.	current (mA rms.)		Dir	n. (mm)	
ranno	raitino	(V D.C.)	(µr)	max.	(µA) max.	max. *1	φD	L	P	ød
	ECA1HM0R1	50	0.1	0.12	3.0	1.3	5	11	2.0	0.50
and an and a second	ECA1HMR22	50	0.22	0.12	3.0	2.9	5	11	2.0	0.50
	ECA1HMR33	50	0.33	0.12	3.0	4.4	5	11	2.0	0.50
	ECA1HMR47	50	0.47	0.12	3.0	5	5	11	2.0	0.50
	ECA1HMR68	50	0.68	0.12	3.0	7	5	11	2.0	0.50
	ECA1HM010	50	1	0.12	3.0	10	5	11	2.0	0.50
	ECA1HM2R2	50	2.2	0.12	3.0	20	5	11	2.0	0.50
Martin (1997)	ECA1HM3R3	50	3.3	0.12	3.0	35	5	11	2.0	0.50
	ECA1HM4R7 ECA1HM6R8	50 50	4.7 6.8	0.12	3.0 3.0	45 7	5	11 11	2.0	0.50
	ECA1HMI0R8	50	10	0.12	5.0	65	5	11	2.0	0.50
	ECA1HM100	50	22	0.12	11.0	100	5	11	2.0	0.50
	ECA1HM330	50	33	0.12	16.5	110	5	11	2.0	0.50
	ECA1HM470	50	47	0.12	23.5	130	6.3	11.2	2.5	0.50
	ECA1HM101	50	100	0.12	50.0	250	8	11.5	3.5	0.60
	ECA1HM221	50	220	0.12	110.0	400	10	12.5	5.0	0.60
	ECA1HM331	50	330	0.12	165.0	500	10	16	5.0	0.60
	ECA1HM471	50	470	0.12	235.0	650	10	20	5.0	0.60
	ECA1HM102	50	1000	0.12	500.0	1050	12.5	25	5.0	0.60
*******	ECA1HM222	50 50	2200 3300	0.14	1100.0	1300 1500	16	31.5 35.5	7.5	0.80
	ECA1HM332	- 50	3300	0.16	1650.0	1500	10		1.5	0.80
	ECA1JM010	63	1	0.11	3.0	15	5	11	2.0	0.50
	ECA1JM2R2	63	2.2	0.11	3.0	25	5	11	2.0	0.50
	ECA1JM4R7	63	4.7	0.11	3.0	50	5	11	2.0	0.50
	ECA1JM100	63	10	0.11	6.3	70	5	11	2.0	0.50
	ECA1JM220	63	22	0.11	13.8	105	5	11	2.0	0.50
	ECA1JM330	63	33	0.11	20.7	130	6.3	11.2	2.5	0.50
	ECA1JM470	63	47	0.11	29.6	160	6.3	11.2	2.5	0.50
10002-000-00-00-00-00-00-00-00-00-00-00-0	ECA1JM101	63	100	0.11	63.0	270	8	11.5	3.5	0.60
	ECA1JM101S ECA1JM221	63 63	100 220	0.11 0.11	63.0 138.6	<u>270</u> 450	10 10	12.5 16	5.0	0.60
	ECAIJM221 ECAIJM331	63	330	0.11	207.9	550	10	20	5.0	0.60
	ECA1JM471	63	470	0.11	296.1	750	12.5	20	5.0	0.60
	ECA1JM102	63	1000	0.11	630.0	1100	16	25	7.5	0.80
	ECA1JM222	63	2200	0.13	1386.0	1400	18	35.5	7.5	0.80

ng lead type Matsushita Part No CCA2AMR47	A W.V. (V D.C.)	Сар	1 Series tan δ max.	L.C.	Ripple current			Page	2 14
Matsushita Part No	1 1		1	L.C.			*****		Marting Cookendral Service and
Part No	1 1		1	L.C.					*****
	(V D.C.)	(µF)	mov		1 1		Dim.	(mm)	
CA2AMR47	5 A		max.	(µA) max.	(mA rms.) max. *1	φD	L	P	ød
A MARA ANY A A T A A T A A T A A T A A T A A T A A T A A T A A T A A T A A A T A A A T A A A A A A A A A	100	0.47	0.06	3.0	10	5	11	2.0	0.50
CA2AM010	100	1	0.06	3.0	20	5	11	2.0	0.50
CA2AM2R2	100	2.2	0.06	3.0	30	5	11	2.0	0.50
CA2AM3R3	100	3.3	0.06	3.0	40	5	11	2.0	0.50
	;;						Construction of the local division of the lo	And the second se	0.50
	la l								0.50
			Ş	the second s	Surgers and a surger second				0.50
Contraction of the second s									0.60
				A					0.60
	·						www.comerce.comerce.comerce.com	Company of the second se	0.60
				and the second se					0.60
		the second s							0.60
									0.80
CI 12/11/11/2		1000	0.00	1000.0	1,500	10		1.5	0.00
CA2CMR47	160	0.47	0.16	3.0	9.5	5	11	2.0	0.50
		1			and the second se				0.50
CA2CM2R2		2.2						the second se	0.50
CA2CM3R3	160	3.3	0.16	5.3	66	6.3	11.2	2.5	0.50
CA2CM4R7	160	4.7	0.16	7.5	78	6.3	11.2	2.5	0.50
CA2CM6R8	160	6.8	0.16	10.9	86	8	11.5	3.5	0.60
CA2CM100	160	10	0.16	16.0	105	10	12.5	5.0	0.60
CA2CM220	160	22	0.16	35.2	175	10	16	5.0	0.60
CA2CM330	160	33				10	20	5.0	0.60
CA2CM470	160				Constant and the second s		20		0.60
	monorman and a second							Service and the service of the servi	0.60
······				CONTRACTOR OF CONT					0.80
CA2CM471	160	470	0.16	752.0	1440	18	40	7.5	0.80
CA2DM010	200	1	0.18	3.0	34	6.3	11.2	2.5	0.50
CA2DM2R2	200	2.2	0.18	4.4	50	6.3	11.2	2.5	0.50
CA2DM3R3	200	3.3	0.18	6.6	62	6.3	11.2	2.5	0.50
CA2DM4R7	200	4.7	0.18	9.4	86	8	11.5	3.5	0.60
CA2DM100	200	10	0.18	20.0	100	10	12.5	5.0	0.60
CA2DM220	200	22	0.18	44.0	180	10	20	5.0	0.60
		33	0.18	66.0	220	10		5.0	0.60
				A	the second s		No. of Concession, Name	and the second se	0.60
			****						0.80
And the state of the second		(managed and the second se							0.80
			and the second se			(and the second s	NEW COLOR CO		0.80
CA2DM221U CA2DM331U	200	330					*****	And the second s	0.80
JALDIVI.3.3 I U I	200	330	0.18	660.0 660.0	<u>1140</u> 1140	18 18	35.5	7.5 7.5	0.80
	CA2AM4R7 CA2AM100 CA2AM220 CA2AM330 CA2AM330 CA2AM470 CA2AM101 CA2AM221 CA2AM331 CA2AM221 CA2AM331 CA2AM102 CA2CM71 CA2CM100 CA2CM2R2 CA2CM3R3 CA2CM4R7 CA2CM6R8 CA2CM100 CA2CM220 CA2CM330 CA2CM470 CA2CM470 CA2CM101 CA2CM221 CA2CM471 CA2DM010 CA2DM2R2 CA2DM010 CA2DM2R2 CA2DM3R3 CA2DM4R7 CA2DM4R7 CA2DM100	CA2AM4R7 100 CA2AM100 100 CA2AM220 100 CA2AM330 100 CA2AM330 100 CA2AM330 100 CA2AM330 100 CA2AM470 100 CA2AM101 100 CA2AM221 100 CA2AM331 100 CA2AM331 100 CA2AM331 100 CA2AM471 100 CA2AM102 100 CA2CM102 100 CA2CM102 100 CA2CM103 160 CA2CM333 160 CA2CM4R7 160 CA2CM100 160 CA2CM330 160 CA2CM101 160 CA2CM101 160 CA2CM101 160 CA2CM21 160 CA2CM21 160 CA2CM471 160 CA2CM471 160 CA2CM471 160 CA2DM100 200	CA2AM4R7 100 4.7 CA2AM100 100 10 CA2AM220 100 22 CA2AM330 100 33 CA2AM330 100 47 CA2AM101 100 47 CA2AM101 100 47 CA2AM101 100 200 CA2AM221 100 220 CA2AM331 100 330 CA2AM471 100 470 CA2AM102 100 1000 CA2CMR47 160 0.47 CA2CM102 100 1000 CA2CM102 160 2.2 CA2CM101 160 1 CA2CM102 160 2.2 CA2CM33 160 3.3 CA2CM47 160 4.7 CA2CM30 160 33 CA2CM101 160 100 CA2CM20 160 22 CA2CM330 160 33 CA2CM101 160	CA2AM4R7 100 4.7 0.06 CA2AM100 100 10 0.06 CA2AM220 100 22 0.06 CA2AM330 100 33 0.06 CA2AM30 100 47 0.06 CA2AM470 100 47 0.06 CA2AM101 100 100 0.06 CA2AM221 100 220 0.06 CA2AM331 100 330 0.06 CA2AM471 100 470 0.06 CA2AM102 100 1000 0.06 CA2AM102 100 1000 0.06 CA2AM102 100 1000 0.06 CA2AM102 100 1000 0.06 CA2CM101 160 1 0.16 CA2CM101 160 1 0.16 CA2CM33 160 3.3 0.16 CA2CM47 160 4.7 0.16 CA2CM470 160 47 0.	CA2AM4R7 100 4.7 0.06 3.0 CA2AM100 100 10 0.06 10.0 CA2AM220 100 22 0.06 22.0 CA2AM330 100 33 0.06 33.0 CA2AM470 100 47 0.06 47.0 CA2AM101 100 100 0.06 100.0 CA2AM221 100 220 0.06 220.0 CA2AM331 100 330 0.06 330.0 CA2AM471 100 470 0.06 470.0 CA2AM102 100 1000 0.06 1000.0 CA2AM102 100 1.16 3.0 CA2CM20 160 1.0 CA2CM101 160 1.4.7 0.16 7.5 CA2CM68	CA2AM4R7 100 4.7 0.06 3.0 50 CA2AM100 100 10 0.06 10.0 70 CA2AM220 100 22 0.06 22.0 115 CA2AM330 100 33 0.06 33.0 145 CA2AM470 100 47 0.06 47.0 180 CA2AM101 100 100 0.06 100.0 350 CA2AM221 100 220 0.06 220.0 550 CA2AM331 100 330 0.06 330.0 700 CA2AM471 100 470 0.06 470.0 900 CA2AM102 100 1000 0.06 1000.0 1300 CA2CMR471 160 0.47 0.16 3.0 36 CA2CM101 160 1 0.16 3.0 36 CA2CM282 160 2.2 0.16 3.5 53 CA2CM487 160 4.7 </td <td>$\begin{array}{c ccccccccccccccccccccccccccccccccccc$</td> <td>$\begin{array}{c ccccccccccccccccccccccccccccccccccc$</td> <td>$\begin{array}{c ccccccccccccccccccccccccccccccccccc$</td>	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

		A	Туре М	1 Series					Page	: 15
Standard	long lead type							I		
Customer	Matsushita	W.V.	Cap	tan δ	L.C.	Ripple current		Dim.	(mm)	977710000000000000000000000000000000000
Part No	Part No	(V D.C.)	(µF)	max.	(µA) max.	(mA rms.) max. *1	φD	L	P	6d
	ECA2EMR47	250	0.47	0.18	3.0	34	φD 5	11	2.0	0.50
	ECA2EM010	250	1	0.18	3.0	34	6.3	11.2	2.5	0.50
	ECA1EM2R2	250	2.2	0.18	5.5	50	6.3	11.2	2.5	0.50
	ECA2EM3R3	250	3.3	0.18	8.3	72	8	11.5	3.5	0.60
	ECA2EM4R7	250	4.7	0.18	11.8	86	8	11.5	3.5	0.60
	ECA2EM100	250	10	0.18	25.0	110	10	16	5.0	0.60
	ECA2EM220	250	22	0.18	55.0	180	10	20	5.0	0.60
	ECA2EM220U	250	22	0.18	55.0	180	10	16	5.0	0.60
	ECA2EM330	250	33	0.18	82.5	250	12.5	20	5.0	0.60
	ECA2EM470	250	47	0.18	117.5	330	12.5	25	5.0	0.60
L	ECA2EM101	250	100	0.18	250.0	530	16	31.5	7.5	0.80
<u> </u>	ECA2EM101S ECA2EM221	250 250	<u>100</u> 220	0.18	250.0 550.0	530 930	<u>18</u> 18	20 40	7.5	0.80
<u> </u>	ECAZEMIZZI	230	220	0.18	550.0	930	10	40	1.3	0.80
	ECA2VM010	350	1	0.20	3.5	32	6.3	11.2	2.5	0.50
	ECA2VM010 ECA2VM2R2	350	2.2	0.20	7.7	55	8	11.5	3.5	0.60
	ECA2VM3R3	350	3.3	0.20	11.6	60	8	11.5	3.5	0.60
	ECA2VM4R7	350	4.7	0.20	16.5	65	10	12.5	5.0	0.50
	ECA2VM100	350	10	0.20	35.0	115	10	20	5.0	0.60
	ECA2VM220	350	22	0.20	77.0	195	12.5	20	5.0	0.60
	ECA2VM330	350	33	0.20	115.5	300	16	25	7.5	0.80
	ECA2VM470	350	47	0.20	164.5	325	16	25	7.5	0.80
										ļ
	ECA2GM010	400	1	0.20	4.0	32	6.3	11.2	2.5	0.50
L	ECA2GM2R2	400	2.2	0.20	8.8	50	8	11.5	3.5	0.60
	ECA2GM3R3	400	3.3	0.20	13.2	54 72	10	12.5	5.0	0.60
	ECA2GM4R7 ECA2GM6R8	400 400	<u>4.7</u> 6.8	0.20	18.8 27.2	72	<u>10</u> 10	16 16	5.0 5.0	0.60
	ECA2GM0R8 ECA2GM100	400	10	0.20	40.0	115	10	20	5.0	0.60
	ECA2GM100 ECA2GM220	400	22	0.20	88.0	215	12.5	25	5.0	0.60
	ECA2GM330	400	33	0.20	132.0	275	16	25	7.5	0.80
	ECA2GM470	400	47	0.20	188.0	350	16	31.5	7.5	0.80
	ECA2GM680U	400	68	0.20	272.0	350	16	31.5	7.5	0.80
	ECA2GM820	400	82	0.20	328.0	300	18	35.5	7.5	0.80
	ECA2GM101	400	100	0.20	400.0	600	18	40	7.5	0.80
	ECA2WM010	450	1	0.20	4.5	37	8	11.5	3.5	0.60
	ECA2WM2R2	450	2.2	0.20	9.9	44	10	12.5	5.0	0.60
l	ECA2WM3R3	450	3.3	0.20	14.9	<u>60</u> 70	10	16	5.0	0.60
	ECA2WM4R7	450	4.7	0.20	21.2	79 130	10	20	5.0 5.0	0.60
	ECA2WM100 ECA2WM220	<u>450</u> 450	10 22	0.20	45.0 99.0	210	12.5 16	20 25	7.5	0.60
	ECA2WM220 ECA2WM330	450	33	0.20	148.5	285	16	31.5	7.5	0.80
		130 1		0.20	110.5			5110		0.00
Remark										
*1	120Hz 8:	5°C								
Established Date		Ma	tsushit	Electro	onic De	vices (M)	Sdn. Bł	nd.		
10.06.2004	1					itor Divisi				



Lead 1) Application range		I Electrolytic	Capacitor	EM-O-TE-B-F1
1) Application range	taping (I) for φ5 ~ φ6	5.3	Page 17
This specification is applie tape.		inium electroly	vtic capacitor (JIS:04 type), taped with a single
2) Taping shape and dimension	on :			
φ5			φ6.3	
AP = P = P		W W W		
			I .	[mm]
	Symbol	Dimensions	Tolerance	Remarks
Item	1D	5 (2	1050	
Product diameter	φD I	5 6.3	+ 0.50	
Product diameter Product length	L	11.0 ~ 11.2	+ 1.00	
Product diameter Product length Lead wire diameter	L ød	<u>11.0 ~ 11.2</u> 0.50	$+1.00 \pm 0.05$	
Product diameter Product length Lead wire diameter Product pitch	L ød P	11.0 ~ 11.2 0.50 12.70	+ 1.00 ± 0.05 ± 1.00	
Product diameter Product length Lead wire diameter	L ød	<u>11.0 ~ 11.2</u> 0.50	$+1.00 \pm 0.05$	Specified by the contact face between tape and lead wire
Product diameter Product length Lead wire diameter Product pitch Feed hole pitch	L ød P P0	$ \begin{array}{r} 11.0 &\sim 11.2 \\ 0.50 \\ 12.70 \\ 12.70 \end{array} $	+1.00 ± 0.05 ± 1.00 ± 0.20	
Product diameterProduct lengthLead wire diameterProduct pitchFeed hole pitchHole center to lead wireFeed hole center to product centerLead to lead distance	L	$ \begin{array}{r} 11.0 \sim 11.2 \\ 0.50 \\ 12.70 \\ 12.70 \\ 5.10 \\ 6.35 \\ 2.50 \\ \end{array} $	$ \begin{array}{r} + 1.00 \\ \pm 0.05 \\ \pm 1.00 \\ \pm 0.20 \\ \pm 0.50 \\ \hline \pm 1.00 \\ \pm 0.50 \\ \end{array} $	
Product diameterProduct lengthLead wire diameterProduct pitchFeed hole pitchHole center to lead wireFeed hole center to product centerLead to lead distanceK liner width	L \$\overline{4}d\$ P P0 P1 P2 F W	$ \begin{array}{r} 11.0 \sim 11.2 \\ 0.50 \\ 12.70 \\ 12.70 \\ 5.10 \\ 6.35 \\ 2.50 \\ 18.00 \\ \end{array} $	$ \begin{array}{r} + 1.00 \\ \pm 0.05 \\ \pm 1.00 \\ \pm 0.20 \\ \pm 0.50 \\ \pm 1.00 \\ \end{array} $	between tape and lead wire
Product diameterProduct lengthLead wire diameterProduct pitchFeed hole pitchHole center to lead wireFeed hole center to product centerLead to lead distanceK liner widthCrepe tape width	L \$\overline{4}d\$ P P0 P1 P2 F W W0	$ \begin{array}{r} 11.0 \sim 11.2 \\ 0.50 \\ 12.70 \\ 12.70 \\ 5.10 \\ 6.35 \\ 2.50 \\ 18.00 \\ 6.0 \leq \end{array} $	$\begin{array}{r} + 1.00 \\ \pm 0.05 \\ \pm 1.00 \\ \pm 0.20 \\ \pm 0.50 \\ \pm 1.00 \\ \pm 0.50 \\ \pm 0.50 \\ \pm 0.50 \\ \hline \end{array}$	between tape and lead wire
Product diameterProduct lengthLead wire diameterProduct pitchFeed hole pitchHole center to lead wireFeed hole center to product centerLead to lead distanceK liner widthCrepe tape widthHole position	L \$\overline{4}{\overline{6}{4}}\$ P0 P1 P2 F W W0 W1	$ \begin{array}{r} 11.0 \sim 11.2 \\ 0.50 \\ 12.70 \\ 12.70 \\ 5.10 \\ 6.35 \\ 2.50 \\ 18.00 \\ 6.0 \leq \\ 9.00 \\ \end{array} $	$ \begin{array}{r} + 1.00 \\ \pm 0.05 \\ \pm 1.00 \\ \pm 0.20 \\ \pm 0.50 \\ \hline \pm 1.00 \\ \pm 0.50 \\ \end{array} $	between tape and lead wire
Product diameterProduct lengthLead wire diameterProduct pitchFeed hole pitchHole center to lead wireFeed hole center to product centerLead to lead distanceK liner widthCrepe tape widthHole positionCrepe tape slipping	L \$\$\overline{4}\$ P P0 P1 P2 F W W0 W1 W2	$ \begin{array}{r} 11.0 \sim 11.2 \\ 0.50 \\ 12.70 \\ 12.70 \\ 5.10 \\ 6.35 \\ 2.50 \\ 18.00 \\ 6.0 \leq \\ 9.00 \\ 1.50 \text{ max.} \end{array} $	$\begin{array}{r} + 1.00 \\ \pm 0.05 \\ \pm 1.00 \\ \pm 0.20 \\ \pm 0.50 \\ \pm 1.00 \\ \pm 0.50 \\ \pm 0.50 \\ - \\ \pm 0.50 \\ - \\ - \\ \pm 0.50 \\ - \\ \end{array}$	between tape and lead wire
Product diameterProduct lengthLead wire diameterProduct pitchFeed hole pitchHole center to lead wireFeed hole center to product centerLead to lead distanceK liner widthCrepe tape widthHole positionCrepe tape slippingProduct from hole height	L \$\overline{4}{\verline{6}{4}}\$ P0 P1 P2 F W W0 W1 W2 H	$ \begin{array}{r} 11.0 \sim 11.2 \\ 0.50 \\ 12.70 \\ 12.70 \\ 5.10 \\ 6.35 \\ 2.50 \\ 18.00 \\ 6.0 \leq \\ 9.00 \\ 1.50 \\ max. \\ 18.50 \\ \end{array} $	$\begin{array}{r} + 1.00 \\ \pm 0.05 \\ \pm 1.00 \\ \pm 0.20 \\ \pm 0.50 \\ \pm 1.00 \\ \pm 0.50 \\ \pm 0.50 \\ - \\ \pm 0.50 \\ - \\ + 0.75 / - 0.50 \end{array}$	between tape and lead wire
Product diameterProduct lengthLead wire diameterProduct pitchFeed hole pitchHole center to lead wireFeed hole center to product centerLead to lead distanceK liner widthCrepe tape widthHole positionCrepe tape slippingProduct from hole heightFeed hole diameter	L \$\overline{4}{0}\$ P 0 P 0 P 1 P 2 F W W 0 W 1 W 2 H \$\overline{4}{0}\$	$\begin{array}{c} 11.0 \sim 11.2 \\ 0.50 \\ 12.70 \\ 12.70 \\ 5.10 \\ \hline 6.35 \\ 2.50 \\ 18.00 \\ 6.0 \leq \\ 9.00 \\ 1.50 \text{ max.} \\ 18.50 \\ 4.00 \end{array}$	$\begin{array}{r} + 1.00 \\ \pm 0.05 \\ \pm 1.00 \\ \pm 0.20 \\ \pm 0.50 \\ \pm 1.00 \\ \pm 0.50 \\ \pm 0.50 \\ - \\ \pm 0.50 \\ - \\ - \\ \pm 0.50 \\ - \\ \end{array}$	between tape and lead wire Ditto
Product diameterProduct lengthLead wire diameterProduct pitchFeed hole pitchHole center to lead wireFeed hole center to product centerLead to lead distanceK liner widthCrepe tape widthHole positionCrepe tape slippingProduct from hole height	L \$\overline{4}{\overline{6}{4}}\$ P0 P1 P2 F W W0 W1 W2 H	$ \begin{array}{r} 11.0 \sim 11.2 \\ 0.50 \\ 12.70 \\ 12.70 \\ 5.10 \\ 6.35 \\ 2.50 \\ 18.00 \\ 6.0 \leq \\ 9.00 \\ 1.50 \\ max. \\ 18.50 \\ \end{array} $	$\begin{array}{r} + 1.00 \\ \pm 0.05 \\ \pm 1.00 \\ \pm 0.20 \\ \pm 0.50 \\ \pm 1.00 \\ \pm 0.50 \\ \pm 0.50 \\ - \\ \pm 0.50 \\ - \\ + 0.75 / - 0.50 \end{array}$	between tape and lead wire

 1) Application range This specification is applied to aluminium electrolytic capacitor (JIS:04 type), taped with a sir tape. 2) Taping shape and dimension : (Interpret definition of the second definition of th	Miniature A	luminiu	m Electroly	tic Ca	apacitor	EM-O-TE-B-F17-
This specification is applied to aluminium electrolytic capacitor (JIS:04 type), taped with a sintape. 2) Taping shape and dimension : $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Lea	d taping	(B) for \$5	5 ~ φ 8		Page 18
ItemSymbolDimensionsToleranceRemarksItemSymbolDimensionsToleranceRemarksProduct diameter ϕd 0.00Product lengthL11.0Lead wire diameter ϕd 0.50Specified by the contact faProduct lengthL11.00Feed hole pitchPD12.70 \pm 0.50Specified by the contact fa	This specification is appli	ed to alu	minium elect	trolytic	c capacitor (JIS	:04 type), taped with a single
ItemSymbolDimensionsToleranceRemarksProduct diameter ϕD 56.38 $+$ 0.50Product lengthL11.0 ~ 11.5 $+$ 1.00Lead wire diameter ϕd 0.500.60 \pm 0.05Product pitchP12.70 \pm 1.00Fred hole pitchP012.70 \pm 1.00Specified by the contact faHole center to lead wireP13.85 \pm 0.50Specified by the contact fa	2) Taping shape and dimension	ion :				
ItemSymbolDimensionsToleranceRemarksProduct diameter ϕD 56.38 ± 0.50 Product lengthL $11.0 \sim 11.5$ ± 1.00 Lead wire diameter ϕd 0.50 0.60 ± 0.05 Product pitchP 12.70 ± 1.00 Feed hole pitchP0 12.70 ± 0.20 Hole center to lead wireP1 3.85 ± 0.50 Specified by the contact fa				1		
Product diameter ϕD 56.38 $+ 0.50$ Product lengthL $11.0 \sim 11.5$ $+ 1.00$ Lead wire diameter ϕd 0.50 0.60 ± 0.05 Product pitchP 12.70 ± 1.00 Feed hole pitchP0 12.70 ± 0.20 Hole center to lead wireP1 3.85 ± 0.50	Item	Symbol	Dimensio		Tolerance	[mm]
Product lengthL $11.0 \sim 11.5$ $+ 1.00$ Lead wire diameter ϕd 0.50 0.60 ± 0.05 Product pitchP 12.70 ± 1.00 Feed hole pitchP0 12.70 ± 0.20 Hole center to lead wireP1 3.85 ± 0.50 Specified by the contact fa						incinai KS
Lead wire diameter ϕd 0.50 0.60 ± 0.05 Product pitchP 12.70 ± 1.00 Feed hole pitchP0 12.70 ± 0.20 Hole center to lead wireP1 3.85 ± 0.50			I			
Product pitchP 12.70 ± 1.00 Feed hole pitchP0 12.70 ± 0.20 Hole center to lead wireP1 3.85 ± 0.50			h			
Feed hole pitchP012.70 ± 0.20 Hole center to lead wireP13.85 ± 0.50 Specified by the contact fa		***************************************		0.00		
Hole center to lead wire P1 3.85 ± 0.50 Specified by the contact fa					1	
between tape and lead wire						Specified by the contact face between tape and lead wire
Feed hole center to product centerP2 6.35 ± 1.00	ed hole center to product center	P2			± 1.00	
Lead to lead distance F 5.00 +0.80 / -0.20 Ditto						Ditto
K liner width W 18.00 ± 0.50			***************************************		± 0.50	
Crepe tape widthW0 $6.0 \leq$					-	
Hole positionW1 9.00 ± 0.50					± 0.50	
Crepe tape slipping W2 1.50 max						
Product from hole height H 18.5 20.0 +0.75 / -0.50				20.0		
Product from hole heightH016.00 ± 0.50 The heightH0100 ± 0.20						
Feed hole diameter ϕ D04.00 \pm 0.20LLLLL						0.10.11.1
Inclination of body Δh $1.00 \ge$ - Specified by the edge of						1
Inclination of body ΔP 1.00 \geq - aluminium						
Total tape thicknesst 0.60 ± 0.30 CP wire is not included	tal tape thickness	t	0.60		± 0.30	CP wire is not included

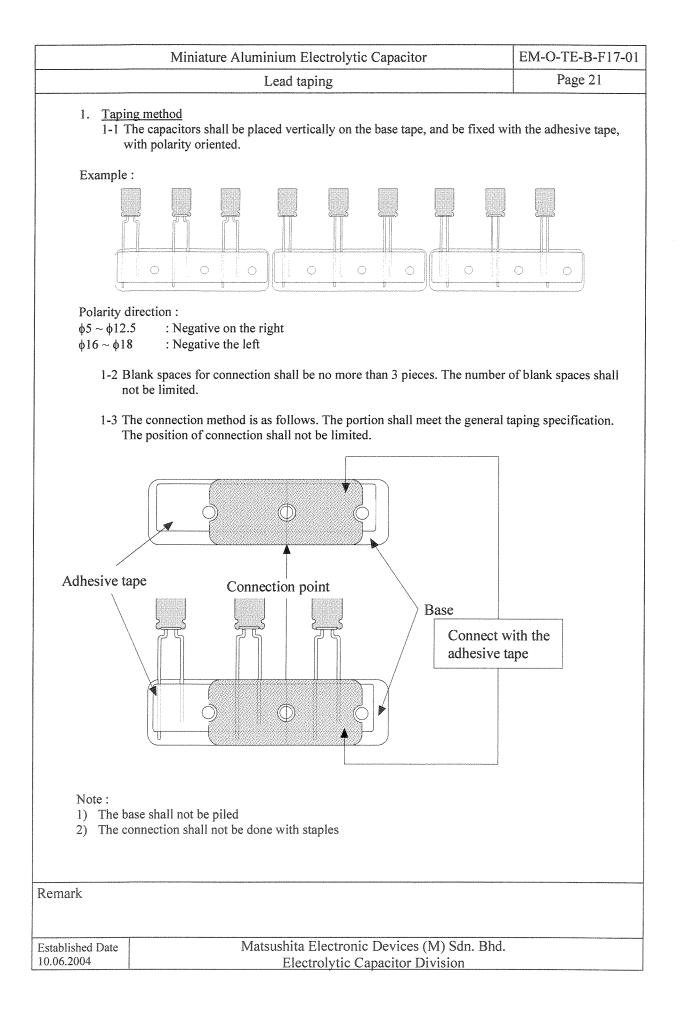
Remark

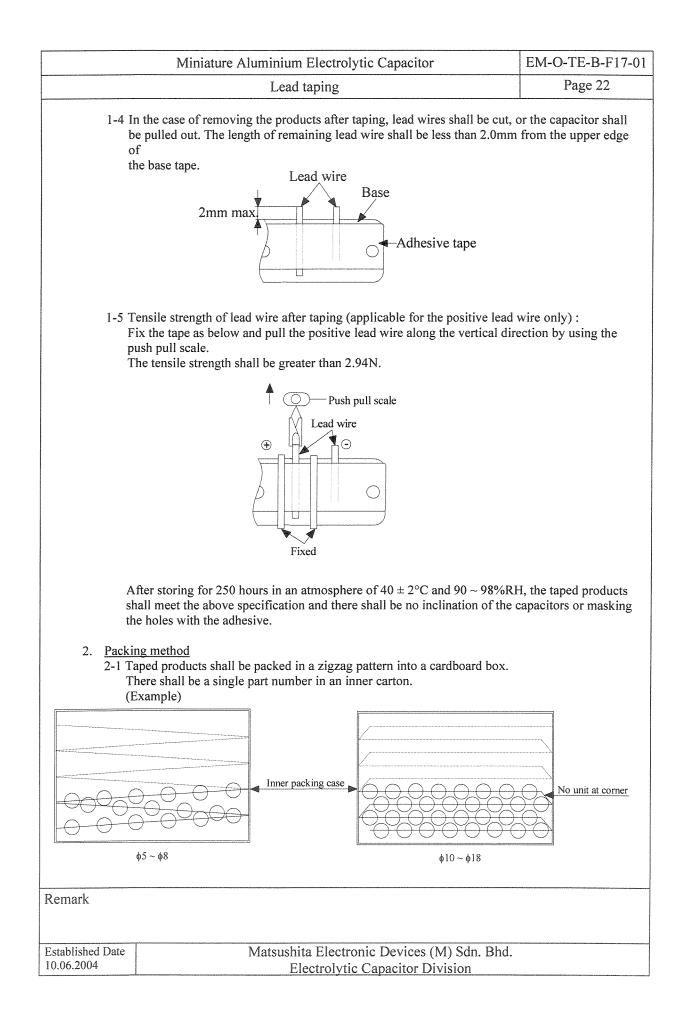
Established Date 10.06.2004

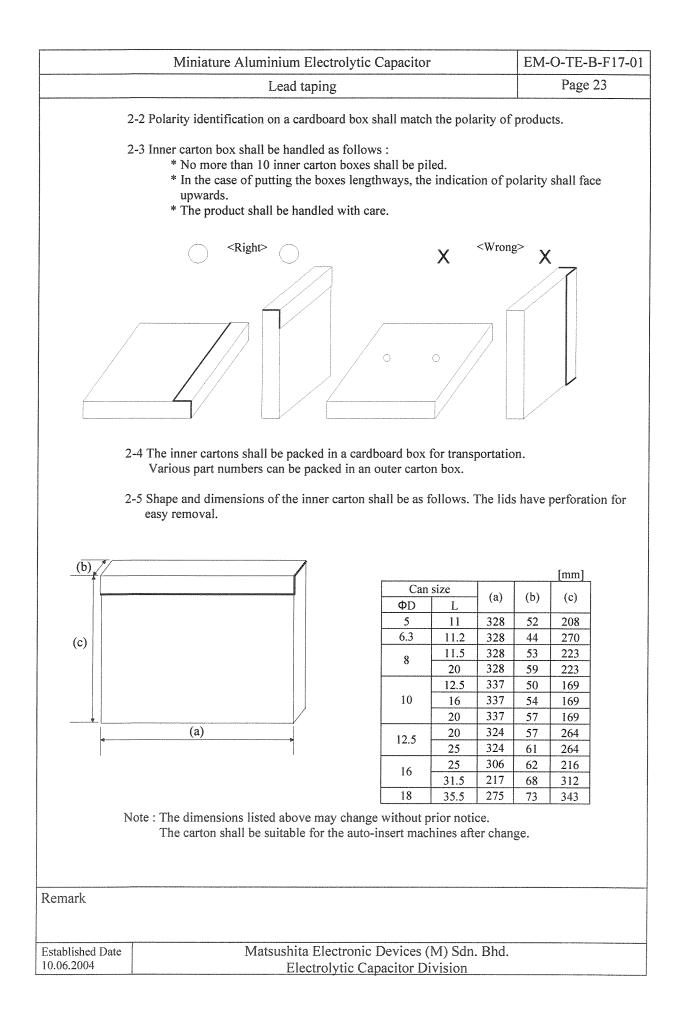
Miniature Aluminium Electrolytic Capacitor					EM-O-TE-B-F17-
Lea	d taping (B) for $\boldsymbol{\phi}$	10 ~ φ 12.	5	Page 19
 Application range This specification is ap tape. 	plied to alu	minium el	ectrolytic	capacitor (JIS:()4 type), taped with a single
2) Taping shape and dime	nsion :				
	1		¢D -		
W W W W W W W W W W W W W W W W W W W		P2 P			
					[mm]
Item	Symbol	Dimer	nsions	Tolerance	Remarks
Product diameter	φD	10	12.5	+ 0.50	
Product length	L		- 25.0	-	
Lead wire diameter	¢d	0.0		± 0.05	
Product pitch	P P	12.70	15.00	± 1.00	
Feed hole pitch Hole center to lead wire	P0 P1	12.70 3.85	15.00 5.00	$\begin{array}{r} \pm 0.20 \\ \pm 0.50 \end{array}$	Specified by the contact face between tape and lead wire
Feed hole center to product center	P2	6.35	7.50	± 1.00	K
Lead to lead distance	F	5.		+0.80 / -0.20	Ditto
K liner width	W	18	.00	± 0.50	
Crepe tape width	W0	6.0)≤	-	
Hole position	W1	9.	00	± 0.50	
Crepe tape slipping	W2	1.5 max.		7 9	
Product from hole height	H		.50	+0.75 / -0.50	
Feed hole diameter	φD0		00	± 0.20	
Inclination of body	Δh	1.00≥		100	Specified by the edge of
Inclination of body	ΔΡ		<u>00≥</u>	-	aluminium
Total tape thickness	t	0.	60	± 0.30	CP wire is not included

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10.06.2004	

Miniature	Alumini	um Elect	olytic Ca	pacitor	EM-O-TE-B-F17-
Lea	d taping (B) for ϕ	16 and \$1	8	Page 20
 Application range This specification is ap tape. 	plied to al	uminium e	lectrolytic	capacitor (JIS:	04 type), taped with a single
2) Taping shape and dime	nsion :				
		1	φD		
<u>M0</u>		P 			
		·			[mm]
Item	Symbol	1	nsions	Tolerance	Remarks
Product diameter	φD	16	18	+ 0.50	
Product length Lead wire diameter	L ød	20~31.5	20~40 80	+ 2.00	
Product pitch	P P	1	.00	$\begin{array}{r} \pm 0.05 \\ \pm 1.00 \end{array}$	
Feed hole pitch	P0		.00	± 0.20	
Hole center to lead wire	P1		75	± 0.50	Specified by the contact face between tape and lead wire
Feed hole center to product center	P2	7.	50	± 1.00	
Lead to lead distance	F	7.	50	± 0.50	Ditto
K liner width	W		.00	± 0.50	
Crepe tape width	W0) ≤	*	
Hole position	W1	9.		± 0.50	
Crepe tape slipping	W2	1.5 1		-	
Product from hole height	H		50	+0.75 / -0.50	
	·····				Specified by the edge of
****				-	1
	t		***************************************	± 0.30	
Feed hole diameter Inclination of body Inclination of body Total tape thickness	φD0 Δh ΔP	4.0	00 0≥ 0≥	± 0.20 - ± 0.30	Specified by the edge of aluminium CP wire is not included
emark stablished Date	Matsu	shita Elec	tronic De	vices (M) Sdi	2 Bbd
tanisched Llate					







Ministry Aluminum Flootnoista Concertan	1
Miniature Aluminium Electrolytic Capacitor EM-O-TE-B-F17-01	1

Lead taping

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2-6 Packing Quantity

Product diameter (Φ)	Inner carton quantity	Outer carton quantity
[mm]	[pcs]	[pcs]
5	2000	10000
6.3	2000	10000
8	1000	5000
10	500	2000
12.5	500	2000
16	250	1000
18	250	500

3. Storage

3-1 The handling method shall follow Item 2-3 which is specified in this specification.

3-2 The product shall not be in contact with direct sunlight and the temperature and humidity shall be normal.

4. Ordering unit

The order placed shall be multiples of inner carton quantity. Example : $h_{2} = h_{3} = h_{3}$; minimum 2 000 pieces

φ5 ~ φ6.3	: minimum 2,000 pieces
φ8	: minimum 1,000 pieces
φ10~φ12.5	: minimum 500 pieces
φ16 ~ φ18	: minimum 250 pieces

Established Date 10.06.2004

	Miniature Aluminium Electrolytic Capacitor	EM-O-TE-B-F17-0
	Application Guidelines	Page 25
Elect frequ these (1) E a) At da b) At in (2) E	t design rating Temperature and Frequency rical parameters for electrolytic capacitors are normally specified at ency. These parameters vary with changes in temperature and frequence changes into consideration. ffects of operating temperature on electrical parameters t higher temperatures, leakage current and capacitance increase while ec- ecreases. t lower temperatures, leakage current and capacitance decrease while ec- ecreases. ffects of frequency on electrical parameters higher frequencies, capacitance and impedance decrease while tan δ incre-	cy. Circuit designers should tak quivalent series resistance (ESR quivalent series resistance (ESR
b) At (E 1.2 Oper (1) E dc te (2) If w Cl te re	align inequencies, supervisitive and impedative detension with tail of mer- lower frequencies, ripple current generated heat will rise due to an increa- SSR). ating Temperature and Life Expectancy Expected life is affected by operating temperature. Generally, each 10° buble the expected life. Use capacitors at the lowest possible temperature mperature. F operating temperatures exceed the maximum guaranteed limit, rapid end ill occur, and irreversible damage will result. heck for maximum capacitor operating temperatures including ambient mperature rise caused by ripple current, and the effects of radiated heat sistors. he formula for calculating expected life at lower operating temperatures is $\frac{T1-T2}{L2} = L1 \times 2^{-10}$ L1 : Guaranteed life (h) at temperature, T1 °C L2 : Expected life (h) at temperature, T2 °C T1 : Maximum operating temperature (°C)	ase in equivalent series resistance C reduction in temperature will ure below maximum guarantee electrical parameter deterioration t temperature, internal capacito t from power transistors, IC's o
The follow addition, r and result Leaking e (1) Revers		apacitor electrical parameters. In the pressure relief vent to operate nay result.
DC c polari (2) Charge Stand applic (3) Overve	apacitors have polarity. Verify correct polarity before insertion. For circ ity, use DC bi-polar capacitors. DC bi-polar capacitors are not suitable for e/Discharge Applications ard capacitors are not suitable for use in repeating charge/discharge ap cation, consult us and advise actual conditions. oltage	r use in AC circuits.
rating AC ri (4) Ripple Do no a capa	ot apply voltages exceeding the maximum specified rated voltage. Vo g are acceptable for short periods of time. Ensure that the sum of the De pple voltage does not exceed the maximum specified rated voltage. Current of apply ripple currents exceeding the maximum specified value. For high acitor designed for high ripple currents or contact us with your requirements superimposed on low DC bias voltage do not cause reverse voltage co	C voltage and the superimpose h ripple current applications, usents. Ensure that allowable ripple
(1) Capac The c ripple	Two or More Capacitor in Series or Parallel citors Connected in Parallel circuit resistance can closely approximate the series resistance of the ca current loads within the capacitors. Careful design of wiring methods sive ripple currents applied to a capacitor.	
stablished Date	Matsushita Electronic Devices (M) Sdn.	Bhd.

	Miniature Aluminium Electrolytic Capacitor	EM-O-TE-B-F17-01
	Application Guidelines	Page 26
Norm	titor Connected in Series al DC leakage current differences among capacitors can cause voltage imba st shunt resistors with consideration to leakage currents, can prevent capacitor	
 1.5 Capa (1) Doub. Avoid a sold cathoo (2) Circui The v proces (3) Circui The c Incorr prema (4) Cleara Capac operat (5) Cleara A hold (6) Wiring Avoid Flamm insula (7) Circuit Avoid 	citor Mounting Considerations le-sided Circuit Boards levering pattern runs which pass between the mounted capacitor and the circuit er bath, excess solder may collect under the capacitor by capillary action and de terminals. It Board Hole Positioning rinyl sleeve of the capacitor can be damaged if solder passes through a lessed parts. Special care when locating hole positions in proximity to capacitors t Board Hole Spacing ircuit board hole spacing should match the capacitor lead wire spacing with ect spacing can cause excessive lead wire stress during the insertion pro- ture capacitor failure doe to short or open circuit, increased leakage current, of ince for Case Mounted Pressure Relief Vents itor with case mounted pressure relief vents requires sufficient clearance ion. The minimum clearances are dependent on capacitor diameters as follows $6.3 \sim \phi 16 \text{mm} : 2 \text{mm} \text{minimum}, \qquad \phi 18 \text{ mm} : 3 \text{mm} \text{minimum}$ ince for Seal Mounted Pressure Relief Vents is in the circuit board directly under the seal vent location is required to allow pre- Near the Pressure Relief Vent locating high voltage or high current wiring or circuit board paths above the prable, high temperature gas exceeding 100°C may be released which could dis- tion and ignite. Board Patterns Under the Capacitor circuit board runs under the capacitor as electrolyte leakage could cause an el	t board. When dipping into short-circuit the anode and ead hole for subsequently is recommended. in the specified tolerances. icess. This may result the relectrolyte leakage. to allow for proper vent s: proper release of pressure. pressure relief vent. ssolve the wire
Do no termin	Terminal Capacitor Mounting of orient the capacitor with the screw terminal side of the capacitor facing al and mounting bracket screws within the torque range specified in the specif ical Isolation of the Capacitor	
(1) Betwe circuit	y isolate the capacitor as follows : en the cathode and the case (except for axially leaded B types) and between the paths. en the extra mounting terminals (on T types) and the anode terminal, cathode	
The vinyl electrically	citor Sleeve sleeve or laminate coating is intended for marking and identification purp insulate the capacitor. ng may split or crack if immersed into solvents such as toluene or xylene, e.	
circuits and (1) Provid	CAUTION!!!! nsider safety when designing equipment and circuits. Plan for worst case d open circuits which could occur during use. e protection circuits and protection devices to allow safe failure modes. n redundant or secondary circuits where possible to assure continued operation.	
2.1 Consid (1) Capacit (2) Transie voltag (3) Capacit	or Handling Techniques eration Before Using ors have a finite life. Do not reuse or recycle capacitors from used equipment. ent recovery voltage may be generated in the capacitor due to dielectric al e can be discharged with a resistor with a value of about 1 k Ω . ors stored for long periods of time may exhibit an increase in leakage current lly applying rated voltage in series with a resistor of approximately 1 k Ω .	osorption. If required, this
Established Date 10.06.2004	Matsushita Electronic Devices (M) Sdn. Bhd. Electrolytic Capacitor Division	

Application Guidelines Page 27 (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitor (5) Dented or runshed capacitors should not be used. The seal integrity can be compromised and loss electrolyte/shortneem life can result. 22 Capacitor Insertion (1) Verify the correct pole spacing before inserting. (3) Verify the correct pole spacing before inserting (1) (4) For encer the seal of the capacitors. For chip type capacitors, excessive mounting pressure can cause high leak current, short circuit, or disconnection. 23 Manual Soldering (1) Observe temperature and time soldering specifications and do not exceed temperatures of 350°C for 3 seconor less. (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it en the capacitor rans. (3) If a solderd capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads. (4) Avoid touching the tip of the soldering conditions (temperature, inc, etc.). Do not exceed the specified limits. (1) Do not immerse the capacitor selow (temperature, inc, etc.). Do not exceed the specified limits. (2) Derve transpace consponents to touch the capacitor during soldering. (2) Do not immerse the capacitor after		Miniature Aluminium Electrolytic Capacitor	EM-O-TE-B-F17-0
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Established Date Matsushita Electronic Devices (M) Sdil. Bild. 10.06.2004 Electrolytic Capacitor Division	Established Date	Matsushita Electronic Devices (M) Sdn. B	hd.

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2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene base polymers.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

2.9 Fumigation

In exporting electronic appliances with aluminium electrolytic capacitors, in some cases fumigation treatment using such halogen compound as methyl bromide is conducted for wooden boxes. If such boxes are not dried well, the halogen left in the box is dispersed while transported and enters in the capacitors inside. This possibly causes electrical corrosion of the capacitors. Therefore, after performing fumigation and drying make sure that no halogen is left. Don't perform fumigation treatment to the whole electronic appliances packed in a box.

3.0 Precaution for using Capacitors

3.1 Environmental Conditions

Capacitors should not be stored or used in the following environments.

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitors.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity condition where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulphide, sulphuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

3.2 Electrical Precaution

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminium case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuiting the area between the capacitor terminals with conductive materials including liquids such as acids and alkaline solutions.

4.0 Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect from the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which exceeds 100°C temperatures. If electrolyte or gas enters the eye, immediately flush the eye with large amount of water. If electrolyte or gas is ingested by mouth, gargle with water. If electrolyte contacts the skin, wash with soap and water.

5.0 Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminium oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail. In-order to keep the capacitor life, we recommend the capacitor store in-doors and temperature between 15° C ~ 35° C. Expiry date of capacitor shall be according to product model or type. Please consult us concerning the product life model by model. After storing exceeding the expiry date of the product, a capacitor should be reconditioned by applying rated voltage in series with a 1000Ω , current limiting resistor for a time period of 30 minutes.

5.1 Environmental Conditions

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulphide, sulphuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

6.0 Capacitor Disposal

When disposing of capacitors, use on of the following methods :

- Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperature to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.
- (2) Disposal of solid waste.
- NOTE : Local laws may have specific disposal requirements which must be followed.

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